

Investigating a Hypothetical Semiconductor Laser Bar with a Smile-Shaped Temperature Profile using a Laser Diode Simulation/Emulation Tool

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Received: 9 December 2012 Accepted: 31 December 2012 Published: 15 January 2013

Abstract

In this paper, Barlase, a semiconductor laser diode emulation tool, is used to emulate the by-emitter degradation analysis of high power semiconductor laser diodes. Barlase is a software that uses a LabView control interface. We have already demonstrated how Barlase works using a hypothetical laser diode bar (multiple emitters) to validate the usefulness of the tool. It should however, be noted that, this scenario is valid for devices at the start of the aging process only. This scenario was investigated to demonstrate Barlase as follows: curved temperature (smile) profile with maximum temperature at the centre of the bar. The result of this simulation scenario shows the successful implementation of Barlase in the by-emitter analysis of laser diodes.

Index terms— by-emitter, emitter, defect, smile-shaped temperature profile, emitter power, quantum well, degradation, threshold current, slope efficiency, band gap

1 Introduction

Research in the optoelectronic field has improved tremendously leading to the widespread use [1] of optoelectronic devices. As a consequence, progress in the development of high power laser bars has skyrocketed due to their high demand and their improved reliability and durability. Numerous applications of high power lasers have therefore emerged, including light detection and ranging and free space optical communications [2], apart from their traditional applications [3] in recent times. Laser bars are designed to emit more power and therefore are the hottest within a bar.

2 II.

3 Materials and Methods

Bars are made up of multiple emitters, and therefore there was a need to find an innovative way to include the interactions between individual emitters within the bar. This gave rise to the Barlase concept as indicated in Figure 1 as a flow chart showing the communication between emitters in a bar. A bar is considered as a monolithic block of multiple emitters connected in parallel with each other with a common voltage connected across them as shown in Figure ??.

4 III.

5 Results and Discussion

In this paper, the scenario investigated was the impact of a curved heatsink temperature profile across the bar, with a maximum temperature at the centre of the bar. The edges of the bar were held at 300 K. Temperature

39 variations of this magnitude (up to 30 K) have been measured in high-power laser bars with 25 - Barlase therefore
 40 presents an attempt to understand further, the by-emitter degradation analysis technique developed over recent
 41 years [4][5][6][7][8]. This tool is also an addition to the by-emitter analysis technique where the effects of certain
 42 factors that affect the degradation of laser emitters/bars can be investigated. Barlase [9] in this book is used to
 43 perform a by-emitter analysis of a laser bar, when a smile-shaped temperature profile is used since it is well known
 44 that central emitters 50 emitters operating at high currents (e.g. 30 A -50 A). Comparing the average current
 45 per emitter in those cases with the hypothetical 8 emitter bar at a current of 10 A investigated here, we see that
 46 the assumed temperature distribution is realistic. Using these values, multi-emitter simulations were carried out
 47 in constant current mode for bar currents of 2, 4, 6, 8 and 10 A. Figure ?? show the heatsink temperature profile
 48 for the investigation, with Table 1 showing the table of values of the heatsink temperatures assigned to each
 49 emitter in the bar.

50 Figure ?? shows the P-I characteristic of the bar together with the P-I and P-V characteristics of each of the
 51 individual emitters. The threshold current and slope efficiency for the bar are also shown as legend in Figure ??a.
 52 From the emitter P-I curves in Figure ??b, the threshold current and slope efficiency have been calculated for
 53 each individual emitter. These quantities are plotted as a function of emitter number in Figure ???. The results
 54 for the different emitters clearly show an increased threshold current, decreased slope efficiency and earlier onset
 55 of thermal roll-over for the hotter emitters (as expected). The threshold currents of the individual emitters vary
 56 by +/- 5% from the average value, whilst the slope efficiencies deviate by +/-3/5% from the average value.
 57 Nevertheless, the hotter emitters draw more current and emit more power. This can be attributed to the fact
 58 that the temperature-induced changes in the "apparent" threshold current and the "apparent" slope efficiency
 59 are opposite to the changes in the actual threshold current and slope efficiency. This is due to the temperature
 60 induced band gap reduction, which lowers the turn-on voltage and strongly affects the current competition
 61 between emitters. Strain-induced changes in the band gap energy are expected to give similar behaviour of the
 62 apparent threshold current and slope efficiency, but this is not expected for increases in the defect or trap density
 63 (since it does not change the turn-on voltage of the diode). Finally, this example also shows temperature as a
 64 principal cause of emitter threshold current and slope efficiency variations. Figure 6 shows the distribution of
 65 current, power and maximum quantum well (QW) temperature across the bar for a total bar current of 2 A.
 66 Figure ?? shows the same quantities for a total bar current of 10 A. The horizontal broken lines in Figures 6
 67 and 7 represent the ideal values of emitter current and power found by dividing the values from the total bar P-I
 68 characteristic by the number of emitters. In these graphs, the effects of current competition and the distribution
 69 of the power between emitters are made clear. The emitter currents vary by up to +/-10% from the average
 70 value, whilst the emitter output powers vary by up to +/-3/5%. Barlase therefore has been again used in this
 71 scenario to gain more knowledge about the interaction between emitters in a laser bar when a curved temperature
 72 (smile) profile with maximum temperature at the centre of the bar is investigated. In fact, this is the practical
 73 outcome of most semiconductor laser bars as the central emitters emit more power and therefore degrade faster
 74 with aging [10].

75 IV.

76 6 Conclusion

77 The case investigated in this paper using multiemitter simulations show that variations in the operating conditions
 78 and environment of the individual emitters also affect the performance of other emitters and of the bar as a whole.
 79 The introduction of a non-uniform temperature profile caused the most significant change in the bar and emitter
 80 operating conditions and in its performance. However, it should be remembered that this scenario is for devices
 81 at the start of the aging process. When all of the relevant effects are combined and allowed to interact over time,
 82 high levels of defects are expected to play a more important role. This will be caused by current competition
 83 due to a reduction in the turn-on voltage as a result of local temperature and/or strain-induced changes in the
 84 band gap energy. Indeed, it is well known that the propagation and growth of defects increases with increasing
 85 temperature. Thus, the rate of defect generation and propagation within emitters are inextricably linked with
 86 the temperature profile of the bar.

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Figure 1: Figure 1 :

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Emitter Number	Heatsink Temperature	(K)
1	300	
2	310	
3	320	
4	330	
5	330	
6	320	
7	310	
8	300	

Figure 2: Table 1 :

88 .1 Acknowledgement

89 CKA thanks the University of Mines and Technology, Tarkwa, Ghana and the GetFund for their support.

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